

Electronic Patent Application Fee Transmittal

Application Number:	10646897			
Filing Date:	22-Aug-2003			
Title of Invention:	SEMICONDUCTOR COMPONENT HAVING THINNED DIE WITH CONTACT BUMPS AND POLYMER LAYERS ON SIX SIDES			
First Named Inventor/Applicant Name:	Warren M. Farnworth			
Filer:	Stephen A. Gratton			
Attorney Docket Number:	01-1059.1			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
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